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Dated: April 1, 2005

Signature: Matthew E. Hanlev

(Matthew E. Hanlev)

Docket No: TESSERA 3.0-297
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Masud Beroz

Application No.: 10/600,186

Filed: June 20, 2003

For: SIMPLIFIED STACKED CHIP
ASSEMBLIES

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: Confirmation No. 8841
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: Group Art Unit: 2811
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: Examiner: J. M. Im
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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

Dear Sir:

In response to the Office Action mailed December 2, 2004, applicant submits the following remarks.

A listing of claims begins on page 2 of this paper.

Remarks begin on page 5 of this paper.